

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
KPBA-3010SURKSGC	Hyper Red (AlGaInP)	Water Clear	120	300	140°
			*40	*80	
	Super Bright Green (GaP)		5	15	
			*5	*15	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
- *Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Super Bright Green	645 565		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red Super Bright Green	630 568		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Super Bright Green	28 30		nm	IF=20mA
C	Capacitance	Hyper Red Super Bright Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Super Bright Green	1.95 2.2	2.5 2.5	V	IF=20mA
IR	Reverse Current	Hyper Red Super Bright Green		10 10	uA	VR = 5V

Notes:

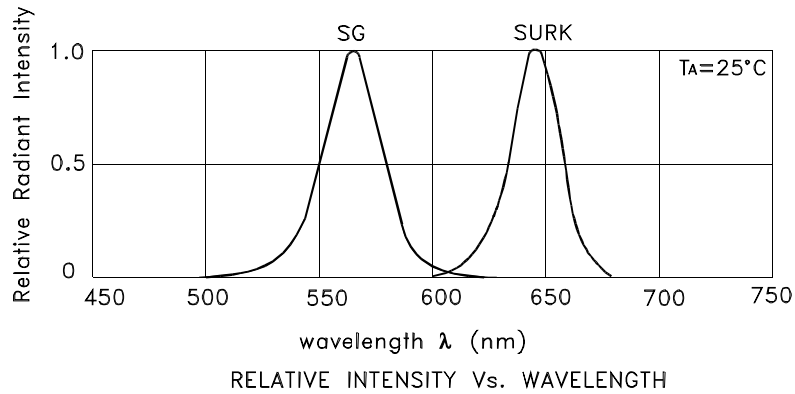
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

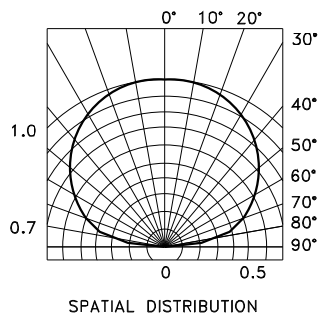
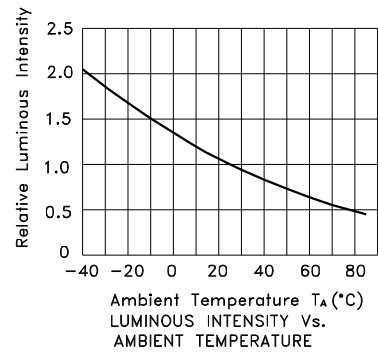
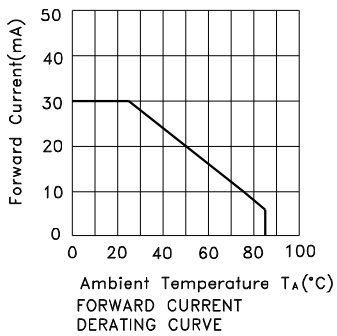
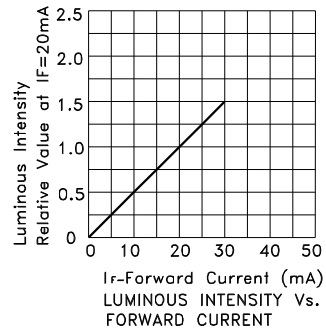
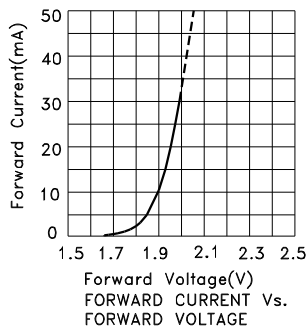
Parameter	Hyper Red	Super Bright Green	Units
Power dissipation	75	62.5	mW
DC Forward Current	30	25	mA
Peak Forward Current [1]	185	140	mA
Reverse Voltage	5		V
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:

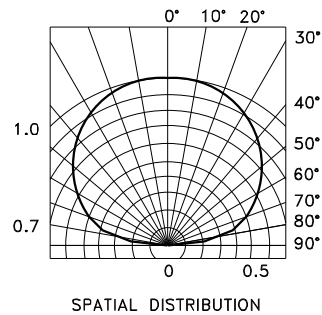
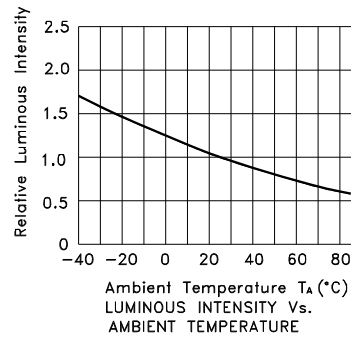
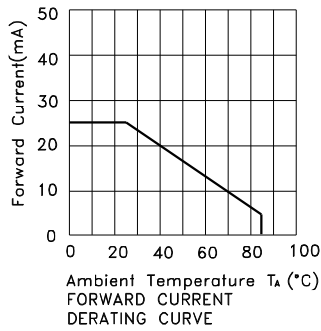
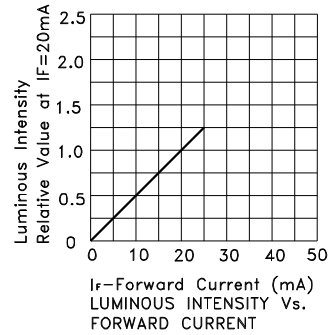
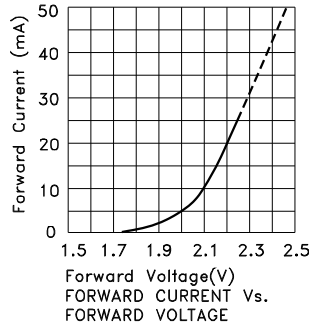
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



KPBA-3010SURKSGC Hyper Red



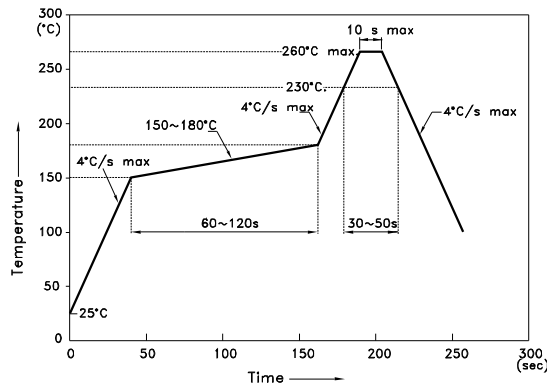
Super Bright Green



KPBA-3010SURKSGC

Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

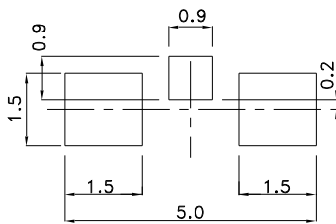
Reflow Soldering Profile For Lead-free SMT Process.



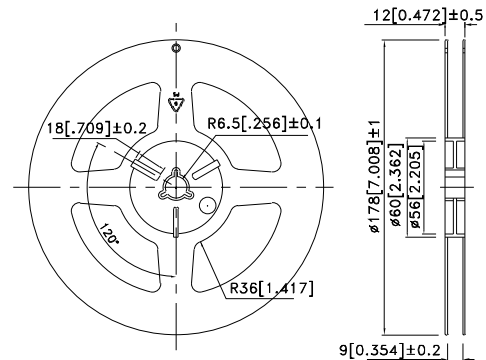
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

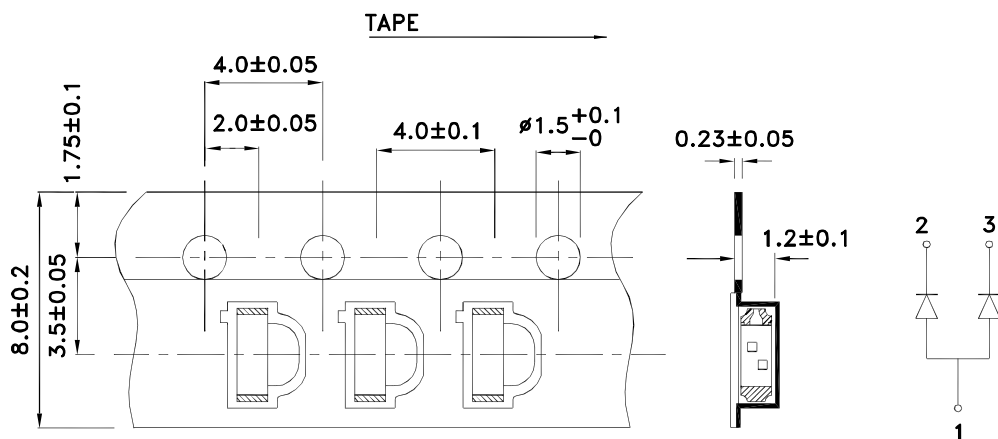
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension

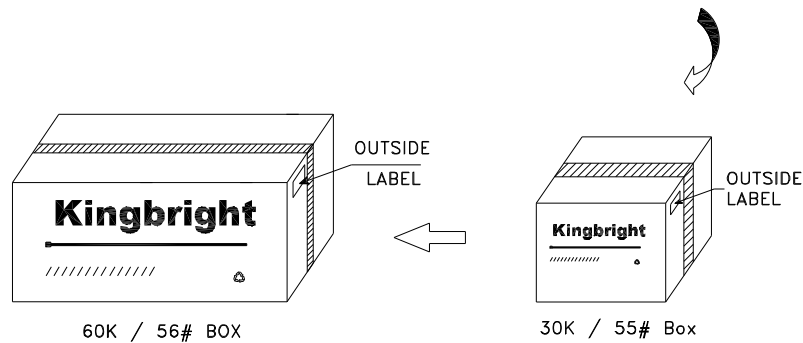
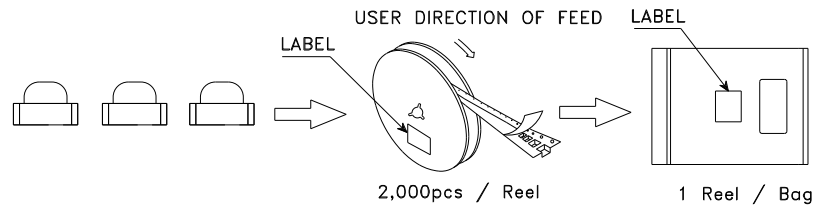



Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS

KPBA-3010SURKSGC



Kingbright	
P/NO: KPBA-3010XXX	
QTY: 2,000 pcs	Q.C. Q C xx xx xxxx PASSED
S/N: XXXX	
CODE: XXX	
LOT NO:	
 <small>XXXXXXXXXXXXXXXXXXXX</small>	
RoHS Compliant	

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